

Features

- 3.3V Input Voltage
- 20-A Output Current
- 4-Bit Programmable Output: 1.3V to 2.05V
- High Efficiency (87%)
- Differential Remote Sense
- Over-Current Protection
- 27-Pin Space-Saving Package
- Solderable Copper Case
- Compatible with PT7744 20A "Current Booster"

Description

The PT7712 Excalibur™ power module is a 20-A integrated switching regulator (ISR) housed a 27-pin space-saving copper package. Operating from a 3.3V input bus, the PT7712 produces a tightly regulated output voltage that is programmable over the range, 1.3V to 2.05V. The output voltage is selected via a 4-bit code, which is compatible with the VRM specifications defined by Intel®.

This regulator is most suitable for microprocessor and DSP applications requiring core or I/O logic supply voltages as low as 1.3V.

The PT7712 incorporates output short-circuit protection, and a differential remote sense to compensate for voltage drop between the regulator and load.

Ordering Information

PT7712□ = 1.3 to 2.05 Volts

PT7744□ = 20-A Booster *

* Consult the related application note for information on current booster operation.

PT Series Suffix (PT1234x)

Case/Pin Configuration	Order Suffix	Package Code [†]
Vertical	N	(FNE)
Horizontal	A	(ENF)
SMD	C	(ENG)

[†] Previously known as package styles 1420 & 1430

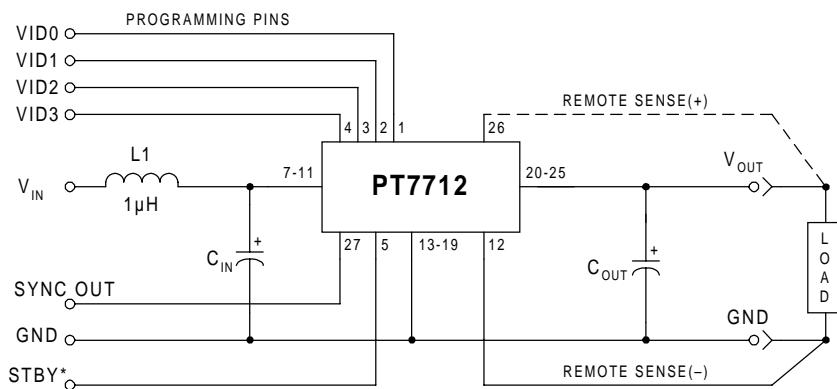
(Reference the applicable package code drawing for the dimensions and PC board layout)

Pin-Out Information

Pin Function	Pin Function
1 VID0	15 GND
2 VID1	16 GND
3 VID2	17 GND
4 VID3	18 GND
5 STBY *	19 GND
6 No Connect	20 V _{out}
7 V _{in}	21 V _{out}
8 V _{in}	22 V _{out}
9 V _{in}	23 V _{out}
10 V _{in}	24 V _{out}
11 V _{in}	25 V _{out}
12 Rem Sense Gnd	26 Rem Sense V _{out}
13 GND	27 Sync Out
14 GND	

For STBY* pin: open =output enabled
ground =output disabled.

Standard Application



C_{in} = Required 1500μF electrolytic
C_{out} = Required 330μF electrolytic
L₁ = Optional 1μH input choke

Programming Information

VID3	VID2	VID1	VID0	Vout
1	1	1	1	1.30V
1	1	1	0	1.35V
1	1	0	1	1.40V
1	1	0	0	1.45V
1	0	1	1	1.5V
1	0	1	0	1.55V
1	0	0	1	1.60V
1	0	0	0	1.65V
0	1	1	1	1.70V
0	1	1	0	1.75V
0	1	0	1	1.80V
0	1	0	0	1.85V
0	0	1	1	1.90V
0	0	1	0	1.95V
0	0	0	1	2.00V
0	0	0	0	2.05V

Logic 0 = Pin 12 potential (remote sense gnd)

Logic 1 = Open circuit (no pull-up resistors)

VID3 must not be changed while the unit is operating.

PT7710 Product Family Comparison

Product	Input Voltage	Description	Adjust Method	Output Range
PT7711	5V	VID	5-Bit	1.3V– 3.5V
PT7712	3.3V	VID	4-Bit	1.3V– 2.05V
PT7713	3.3V	VID	4-Bit	1.8V– 2.55V
PT7714	3.3V	VID	5-Bit	0.8V–1.575V
PT7715	5V	VID	5-Bit	1.075V–1.85V
PT7716	3.3V	VID	5-Bit	1.075V–1.85V
PT7744	3.3V	Booster	—	—
PT7745	5V	Booster	—	—

Specifications (Unless otherwise stated, $T_a = 25^\circ\text{C}$, $V_{in} = 3.3\text{V}$, $C_{in} = 1,500\mu\text{F}$, $C_{out} = 330\mu\text{F}$, $V_o = 1.8\text{V}$, and $I_o = I_{o,\text{max}}$)

Characteristics		Symbols	Conditions	Min	Typ	Max	Units
Output Current	I_o		$T_a = +25^\circ\text{C}$, Natural convection $T_a = +60^\circ\text{C}$, 200 LFM, pkg N	0.1 (1) 0.1 (1)	— —	20 19	A
Input Voltage Range	V_{in}		Over I_o range	3.1	—	3.6	V
Set-Point Voltage Tolerance	V_o tol		All output voltages	—	± 10	± 25 (2)	mV
Temperature Variation	Reg_{temp}		$-40^\circ\text{C} \leq T_a \leq +85^\circ\text{C}$, $I_o = I_{o,\text{min}}$	—	± 0.75	—	% V_o
Line Regulation	Reg_{line}		Over V_{in} range	—	± 5	—	mV
Load Regulation	Reg_{load}		Over I_o range	—	± 5	—	mV
Total Output Voltage Variation	ΔV_o tol		Includes set-point, line, load, $-40^\circ\text{C} \leq T_a \leq +85^\circ\text{C}$	—	± 1	± 3	% V_o
Efficiency	η	$I_o = 10\text{A}$	$V_o = 1.8\text{V}$	—	87	—	%
		$I_o = 20\text{A}$	$V_o = 1.8\text{V}$ $V_o = 1.5\text{V}$	— —	85 83	— —	%
V_o Ripple (pk-pk)	V_r		20MHz bandwidth	—	50	—	mV _{pp}
Transient Response	t_{tr}		1A/ μs load step, 50% and 100% $I_{o,\text{max}}$	—	50	—	μSec
	V_{os}		V_o over/undershoot	—	± 100	—	mV
Over-Current Threshold	I_{TRIP}		Reset followed by auto-recovery	—	32	—	A
Switching Frequency	f_o		Over V_{in} range	300	350	400	kHz
STBY* Input Requirements			Referenced to GND				
Input High Voltage	V_{IH}			2.0	—	Open (3)	
Input Low Voltage	V_{IL}			-0.2	—	0.8	V
Input Low Current	I_{IL}		Pin 5 to GND	—	0.3	—	mA
Standby Input Current	I_{in} standby		Pin 5 to GND	—	30	—	mA
External Capacitance	C_{out}			330 (4)	—	15,000	μF
Operating Temperature Range	T_a		Over V_{in} Range	-40	—	+85 (5)	$^\circ\text{C}$
Storage Temperature	T_s			-40	—	+125	$^\circ\text{C}$
Mechanical Shock	—		Per Mil-STD-883D, Method 2002.3 1 msec, Half Sine, mounted to a fixture	—	500	—	G's
Mechanical Vibration	—		Mil-STD-883D, Method 2007.2 20-2000 Hz	Suffixes N, A Suffix C	20 (6) 15 (6)	—	G's
Weight	—		Vertical/Horizontal	—	36	—	grams
Flammability	—		Materials meet UL 94V-0				

Notes: (1) ISR will operate down to no load with reduced specifications.

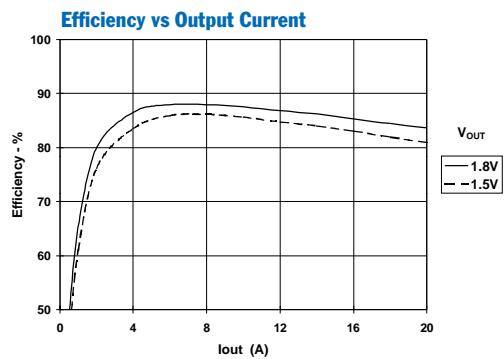
(2) If the remote sense ground is not used, pin 12 must be connected to pin 13 for optimum output voltage accuracy.

(3) The STBY* control (pin 5) has an internal pull-up. If it is left open-circuit, the module will operate when input power is applied. A low-leakage (<1 μA) MOSFET must be used to control this pin. The open-circuit voltage may be as high as V_{in} .(4) For operation below 0 $^\circ\text{C}$, C_{in} and C_{out} must have stable characteristics. Use either low ESR tantalum or Oscon® capacitors.

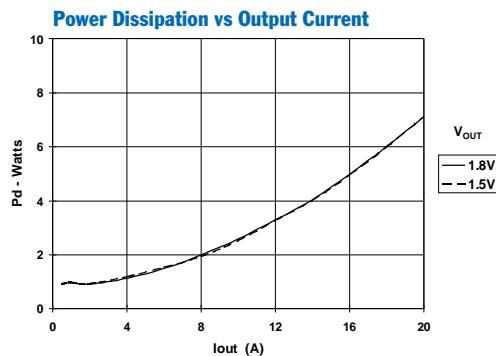
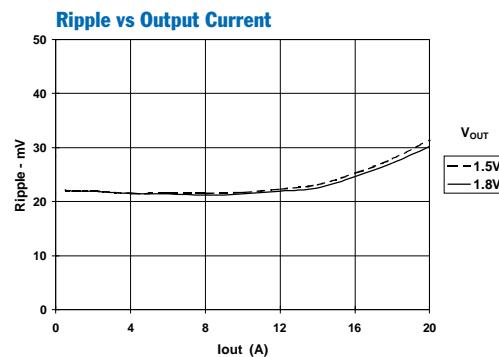
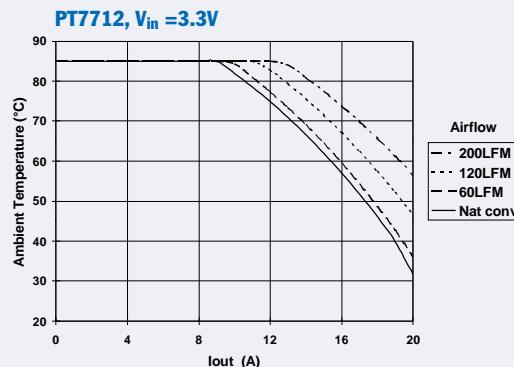
(5) See safe Operating Area curves or consult factory for the appropriate derating.

(6) The case pins on the through-hole package types (suffixes N & A) must be soldered. For more information see the applicable package outline drawing.

External Capacitors: The regulator requires a minimum output capacitance of 330 μF for proper operation. An input capacitance of 1500 μF is also required. This must be rated for a minimum of 1.4A/ μs of ripple current. For transient or dynamic load applications, additional capacitance may be required. For further information refer to the application note regarding capacitor selection for this product.**Input Filter:** An input filter inductor is optional for most applications. The inductor must be sized to handle 20ADC with a typical value of 1 μH .

Performance Characteristics, $V_{in} = 3.3V$ (See Note A)

Safe Operating Area Curves (See Note B)



Note A: All characteristic data in the above graphs has been developed from actual products tested at 25°C. This data is considered typical for the ISR.
Note B: SOA curves represent operating conditions at which internal components are at or below manufacturer's maximum rated operating temperatures.

Capacitor Recommendations for the PT7710 Series of Regulators and Current Boosters

Input Capacitors

The recommended input capacitance is determined by the 1.4 ampere minimum ripple current rating and 1500 μ F minimum capacitance. Capacitors listed below must be rated for a minimum of twice (2 \times) the input voltage with +5V operation. Ripple current and \leq 100m Ω Equivalent Series Resistance (ESR) values are the major considerations along with temperature when selecting the proper capacitor.

Output Capacitors

The minimum required output capacitance is 330 μ F with a maximum ESR less than or equal to 100m Ω . Failure to observe this requirement may lead to regulator instability or oscillation. Electrolytic capacitors have poor ripple performance at frequencies greater than 400kHz, but excellent low frequency transient response. Above the ripple frequency ceramic decoupling capacitors are necessary to improve the transient response and reduce any microprocessor high frequency noise components apparent during higher current excursions. Preferred low ESR type capacitor part numbers are identified in the Table 1-1 below.

Tantalum Characteristics

Tantalum capacitors with a minimum 10-V rating are recommended on the output bus, but only the AVX TPS Series, Sprague 594/595 Series, or Kemet T495/T510 Series. These AVX, Sprague, and Kemet capacitors are specified over other types due to their higher surge current, excellent power dissipation and ripple current ratings. As a caution, the TAJ Series by AVX is not recommended. This series exhibits considerably higher ESR, reduced power dissipation and lower ripple current capability. The TAJ series is also less reliable compared to the TPS series when determining power dissipation capability.

Capacitor Table

Table 1-1 identifies the characteristics of capacitors from a number of vendors with acceptable ESR and ripple current (rms) ratings. The suggested minimum quantities per regulator for both the input and output buses are identified.

This is not an extensive capacitor list. Capacitors from other vendors are available with comparable specifications. The RMS ripple current rating and ESR (Equivalent Series Resistance at 100kHz) are the critical parameters necessary to insure both optimum regulator performance and long capacitor life.

Table 1-1 Capacitors Characteristic Data

Capacitor Vendor/ Series	Capacitor Characteristics					Quantity		Vendor Number
	Working Voltage	Value(μ F)	(ESR) Equivalent Series Resistance	105°C Maximum Ripple Current(lrms)	Physical Size(mm)	Input Bus	Output Bus	
Panasonic FC (SMT)	16V 35V	2200 330	0.038 Ω 0.065 Ω	2000mA 1205mA	18x16.5 12.5x16.5	1	1	EEVFC1C222N EEVFC1V331LQ
	FC (Radial)	10V 16V	560 1800	0.090 Ω 0.032 Ω	755mA 2000mA	10x12.5 18x15	1	EEUFC1A561 EEUFC1C182S
United Chemi -Con LFZ Series	25V	330	0.090 Ω	760mA	10x12.5	1	1	LXZ25VB331M10X12LL
	16V	1500	0.038 Ω	1660mA	12.5x20		1	LXZ16VB222M12X20LL
	16V	470	0.090 Ω	760mA	10x12.5		1	LXZ16VB471M10X12LL
Nichicon PL Series PM Series	10V	680	0.090 Ω	770mA	10x15	1	1	UPL1A681MHH6
	10V	1800	0.044 Ω	1420mA	16x15		1	UPL1A182MHH6
	25V	330	0.095 Ω	750mA	10x15		1	UPL1E331MPH6
Oscon SS (Radial) SVP (SMT)	10V 10V	330 330	0.025 Ω +4 =0.006 Ω 0.02 Ω +4 =0.005 Ω	>9800mA >9800mA	10x10.5 9x8.3	4 4	N/R (Note)	10SS330M 10SVP330M
AVX Tantalum TPS- Series	10V 10V	330 330	0.1 Ω +5 =0.02 Ω 0.06 Ω	3500mA 1826mA	7.3Lx 4.3Wx 4.1H	5 5	1 1	TPSV337M010R0100 TPSV337M010R0060
Sprague Tantalum 595D/594D	10V 10V	330 680	0.045 Ω +4 =0.011 Ω 0.09 Ω	>4500mA >1660mA	7.3L x 5.7W x 4.0H	5 2	1 1	594D337X0010R2T 595D687X0010R2T (Surface Mount)
Kemet Tantalum T510/T495 Series	10V	330	0.035 Ω	2000mA	4.3Wx7.3L x4.0H	5	1	510X337M010AS
	10V	220	0.07 Ω +2 =0.035 Ω	>2000mA		6	2	T495X227M010AS (Surface Mount)
Sanyo Poscap TPB	10V	220	0.04 Ω	3000mA	7.2L x 4.3W x 3.1H	6	2	10TPB220M (Surface Mount)

Note: (N/R) is not recommended for this application, due to extremely low Equivalent Series Resistance (ESR)

Increasing the Output of the PT7710 Family of ISRs with a 20-A Compatible Current Booster

The output of PT7710 family of regulators (PT7711–PT7716) can produce an additional 20-A output using a compatible current booster module. Two booster modules are available. They are the PT7744 and PT7745, which are compatible with regulators that operate off 3.3-V or 5-V input buses respectively. Refer to Table 2-1 for regulator/booster compatibility.

The booster modules are controlled directly by the regulator and effectively add a parallel output stage. They operate synchronously, to provide a low-noise solution. Up to two booster modules can be connected to a PT771x regulator. Each booster added increases the regulator's output current by 20A, for up to 60A of output current.

Current boosters are not stand-alone products, and can only operate with a regulator. They are housed in the same package as the regulator, and share the same mechanical outline. Except for an increase in output current, the overall performance of a regulator/booster combination is identical to that of a stand-alone regulator. For more details refer to the applicable regulator specifications.

Table 2-1; Booster Compatibility

	P7744 Booster (3.3V Input Bus)	P7745 Booster (5V Input Bus)
Regulator		
PT7711		●
PT7712	●	
PT7713	●	
PT7714	●	
PT7715		●
PT7716	●	

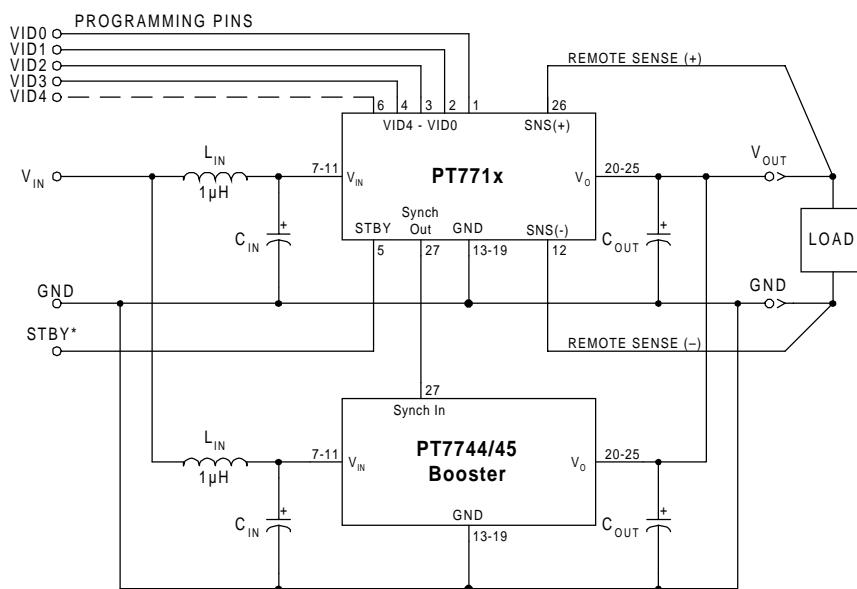
Notes:

1. Each booster requires the same amount of input and output capacitance as recommended for a stand-alone regulator. Consult the individual data sheet of the applicable regulator, and the related application note regarding capacitor selection for this product family.
2. The 1- μ H filter choke located at the input of each regulator and booster module (L_{in}) is optional for most applications. If specified, each inductor must be sized to handle 20ADC at full output load.
3. The pin-out of the current booster modules include a number pins identified, "No Connect" (see Table 2-2). These pins are not connected internally to the module but must be soldered to a pad to preserve the unit's mechanical integrity.
4. A similar PCB footprint and trace layout between the regulator and each booster will facilitate current sharing between all modules.

Table 2-2; Booster Pin-Out Information

Pin	Function	Pin	Function	Pin	Function
1	No Connect	10	V _{in}	19	GND
2	No Connect	11	V _{in}	20	V _{out}
3	No Connect	12	No Connect	21	V _{out}
4	No Connect	13	GND	22	V _{out}
5	No Connect	14	GND	23	V _{out}
6	No Connect	15	GND	24	V _{out}
7	V _{in}	16	GND	25	V _{out}
8	V _{in}	17	GND	26	No Connect
9	V _{in}	18	GND	27	Sync In

Figure 1-1: Current Booster Application Schematic



Using the Standby Function on the PT7710 Excalibur™ Series of 20-A ISRs

For applications requiring On/Off control of the output voltage, the PT7710 family of Excalibur ISRs incorporate a standby function. This feature may be used for power-up/shutdown sequencing, or to change the output voltage while input power is applied. *See related notes:* “Pin-Coded Output Voltage Adjustment of the PT7710 Excalibur™ Series of 20-A ISRs.”

The standby function is provided by the *STBY** control, pin 5. If pin 5 is left open-circuit the regulator operates normally, providing a regulated output whenever a valid supply voltage is applied to V_{in} (pins 7-11) with respect to GND (pins 13-19). Connecting pin 5 to ground 1 will set the regulator output to zero volts ². This places the regulator in standby mode, and reduces the input current to typically 30mA (60mA max). If a ground signal is applied to pin 5 prior to power-up, the regulator output will be held at zero volts during the period that input power is applied.

The standby input must be controlled with an open-collector (or open-drain) discrete transistor (See Figure 1). Table 3-1 gives the input requirements.

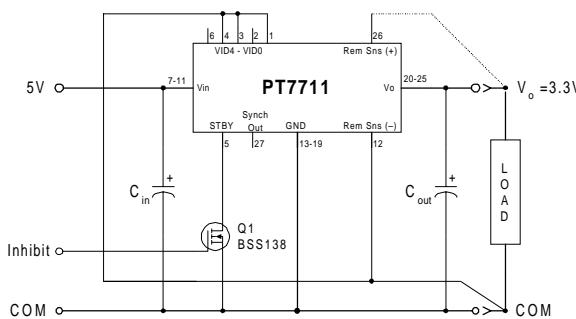
Table 3-1 Standby Control Input Requirements ^(1, 2)

Parameter	Min	Typ	Max
Enable	2V	Open Cct. ¹	
Disable	-0.2V	0.8V	
I_{stby} (low)		0.5mA	
V_{stby} (o/c)		V_{in}	

Notes:

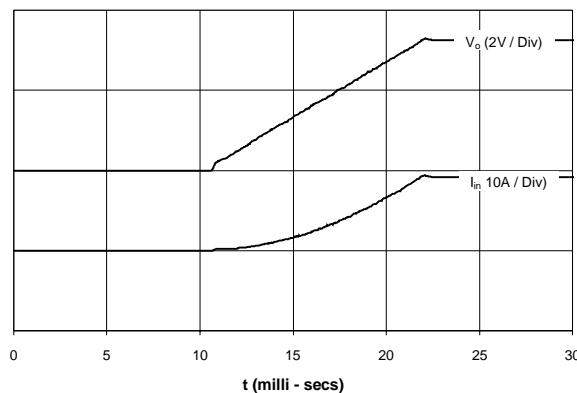
1. The Standby input on the PT7710 regulator family must be controlled using an open-collector (or open-drain) discrete transistor. *Do Not* use a pull-up resistor. The control input has an open-circuit voltage equal to V_{in} . To set the regulator output to zero, the control pin must be “pulled” to less than 0.8Vdc with a 0.5mA sink to ground.
2. When placed in the standby mode, the regulator output discharges the output capacitance with a low impedance to ground.
3. The turn-off time of Q_1 , or rise time of the standby input is not critical with the PT7710 family. Turning Q_1 off slowly, over periods up to 100ms, will not affect regulator operation. However, a slow turn-off time will increase both the initial delay and rise-time of the output voltage.

Figure 3-1



Turn-On Time: Turning Q_1 in Figure 3-1 off, removes the low-voltage signal at pin 5 and enables the output. After a delay of approximately 10ms, the output voltage of a PT771x regulator rises to full regulation within 30ms ³. Figure 3-2 shows the typical output voltage waveform of a PT7711 following the turn-off of Q_1 at time $t = 0$ secs. The output voltage in Figure 3-1 is set to 3.3V by connecting VID0 (pin 1), VID2 (pin 3), and VID3 (pin 4) to the ‘Rem Sense Gnd’ (pin 12)*. The waveform was measured with a +5V input source voltage, and 10-A resistive load.

Figure 3-2



* Consult the data sheet for details on other VID codes.

Pin-Coded Output Voltage Adjustment of the PT7710 Excalibur™ Series of 20-A ISRs

The PT7710 Excalibur™ family of converters incorporate a pin-coded control to adjust the output voltage. This feature uses the control pins VID0–VID4 (pins 1–6). When the control pins are left open-circuit, the ISR output regulates at its default output voltage. Each control pin is internally connected to a precision resistor, which when grounded applies a weighted change to the output voltage. By selectively grounding VID0–VID4, the output voltage of these ISRs can be programmed in incremental steps over the specified output voltage range. The program codes and output voltage range offered by these ISRs are compatible with the Voltage ID specifications defined by Intel Corporation for VRMs (voltage regulator modules). The codes are used by both the Pentium® and Athlon® microprocessors. Refer to Figure 4-1 for the connection schematic, and the respective device Data Sheet for the programming code information.

Notes:

1. The programming convention is as follows:-
 - Logic 0: Connect to pin 12 (Remote Sense Ground).
 - Logic 1: Open circuit/open drain (See notes 2, & 4)
2. Do not connect pull-up resistors to the voltage programming pins.
3. Use pin 12 (Remote Sense Ground) as the logic “0” reference. While the regular ground (pins 13-19) can also be used for programming, doing so will degrade the load regulation of the product. If the remote sense ground is not used, pin 12 must be connected to pin 13 for optimum output voltage accuracy.

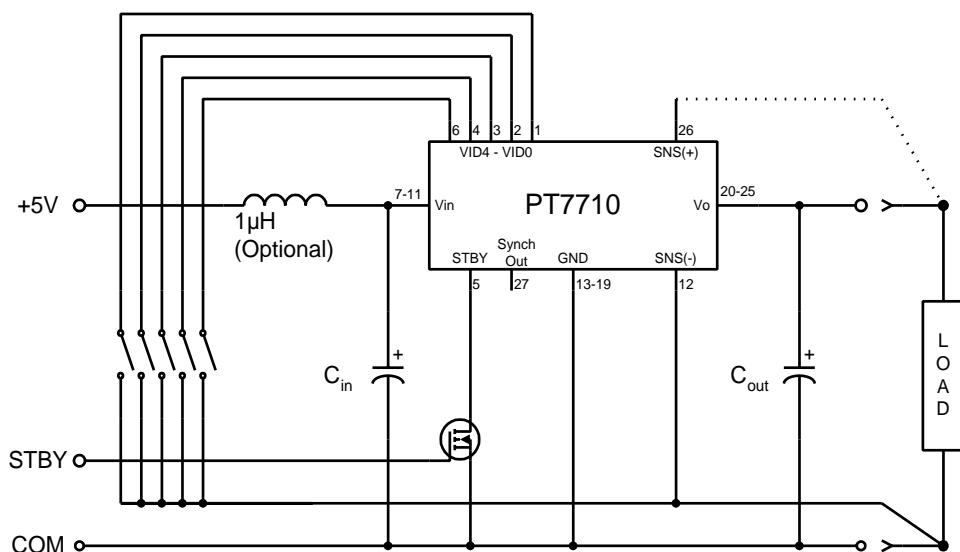
4. If active devices are used to ground the voltage control pins, low-level open drain MOSFET devices should be used over bipolar transistors. The inherent $V_{ce(sat)}$ in bipolar devices introduces errors in the device's internal divider network. Discrete transistors such as the BSS138, 2N7002, or IRLML2402 are examples of appropriate devices.

Active Voltage Programming:

Special precautions should be taken when making changes to the output voltage program code while the unit is powered. This activity can induce current transients through the device as a result of the electrolytic output capacitors being either charged or discharged to the new output voltage set-point. The transient current can be minimized by making only incremental changes to the binary code, i.e. one LSB at a time. A minimum of 100 μ s settling time between each program state is also recommended. Making non-incremental changes to VID3 or VID4 is discouraged.

When active devices are used to program the output voltage, their state should be asserted prior to the input power being applied. An alternative is to pull pin 5 (STBY) control to GND during the application of input voltage, then assert the required program code and release pin 5. The module will then initiate a soft-start power-up to the desired program voltage. For more information on the use of the Standby function, consult the related application note, “Using the Standby Function on the PT7710 Excalibur™ Series of 20-A ISRs.”

Figure 4-1



PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
PT7744A	NRND	SIP MODULE	ENF	27		TBD	Call TI	Call TI	-40 to 85		
PT7744C	NRND	SIP MODULE	ENG	27		TBD	Call TI	Call TI	-40 to 85		

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Multiple Top-Side Markings will be inside parentheses. Only one Top-Side Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Top-Side Marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have **not** been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Products	Applications
Audio	www.ti.com/audio
Amplifiers	amplifier.ti.com
Data Converters	dataconverter.ti.com
DLP® Products	www.dlp.com
DSP	dsp.ti.com
Clocks and Timers	www.ti.com/clocks
Interface	interface.ti.com
Logic	logic.ti.com
Power Mgmt	power.ti.com
Microcontrollers	microcontroller.ti.com
RFID	www.ti-rfid.com
OMAP Applications Processors	www.ti.com/omap
Wireless Connectivity	www.ti.com/wirelessconnectivity
	TI E2E Community
	e2e.ti.com